

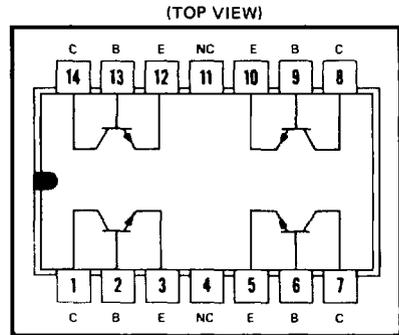
TYPE Q2T2222

QUAD N-P-N SILICON TRANSISTOR

BULLETIN NO. DL-S 7311703, APRIL 1972—REVISED MARCH 1973

**DESIGNED FOR MEDIUM-POWER SWITCHING
AND GENERAL PURPOSE AMPLIFIER APPLICATIONS**

- High Breakdown Voltage Combined with Very-Low Saturation Voltage
- h_{FE} . . . Guaranteed from 100 μ A to 500 mA
- High f_T . . . 250 MHz Min at 20 V, 20 mA



NC—No Internal connection

mechanical data

14-PIN PLASTIC DUAL-IN-LINE PACKAGE

NOTES:

a. The true-position pin spacing is 0.100 between centerlines. Each pin centerline is located within 0.010 of its true longitudinal position relative to pins 4 and 11.

b. All dimensions are in inches unless otherwise noted.

Falls Within JEDEC TO-116 and MO-001AA Dimensions

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absolute maximum ratings at 25°C free-air temperature (unless otherwise noted)

	EACH TRIODE DEVICE	TOTAL DEVICE
Collector-Base Voltage	60 V	
Collector-Emitter Voltage (See Note 1)	30 V	
Emitter-Base Voltage	5 V	
Continuous Collector Current	0.8 A	
Continuous Device Dissipation at (or below) 25°C Free-Air Temperature (See Note 2)	0.5 W†	1.5 W†
Storage Temperature Range	-55°C to 150°C	
Lead Temperature 1/16 Inch from Case for 10 Seconds	← 260°C →	

- NOTES:** 1. This value applies between 0.01 mA and 500 mA collector current when the emitter-base diode is open-circuited.
2. Derate linearly to 150°C free-air temperature at the rates of 4 mW/°C for each triode and 12 mW/°C for the total device.

† Previous editions of this data sheet showed higher power dissipation ratings which have been found to be in error. The new ratings correct these errors and do not represent product changes. USES CHIP N24

TYPE Q2T2222

QUAD N-P-N SILICON TRANSISTOR

electrical characteristics at 25°C free-air temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	MAX	UNIT
$V_{(BR)CBO}$ Collector-Base Breakdown Voltage	$I_C = 10 \mu A, I_E = 0$	60		V
$V_{(BR)CEO}$ Collector-Emitter Breakdown Voltage	$I_C = 10 \text{ mA}, I_B = 0, \text{ See Note 3}$	30		V
$V_{(BR)EBO}$ Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	5		V
I_{CBO} Collector Cutoff Current	$V_{CB} = 50 \text{ V}, I_E = 0$	10		nA
I_{EBO} Emitter Cutoff Current	$V_{CB} = 50 \text{ V}, I_E = 0, T_A = 100^\circ C$	3		μA
h_{FE} Static Forward Current Transfer Ratio	$V_{CE} = 10 \text{ V}, I_C = 100 \mu A$	35		
	$V_{CE} = 10 \text{ V}, I_C = 1 \text{ mA}$	50		
	$V_{CE} = 10 \text{ V}, I_C = 10 \text{ mA}$	75		
	$V_{CE} = 10 \text{ V}, I_C = 150 \text{ mA}$	100	300	
	$V_{CE} = 10 \text{ V}, I_C = 500 \text{ mA}$	30		
V_{BE} Base-Emitter Voltage	$I_B = 15 \text{ mA}, I_C = 150 \text{ mA}$	1.3		V
	$I_B = 50 \text{ mA}, I_C = 500 \text{ mA}$	2.6		
$V_{CE(sat)}$ Collector-Emitter Saturation Voltage	$I_B = 15 \text{ mA}, I_C = 150 \text{ mA}$	0.4		V
	$I_B = 50 \text{ mA}, I_C = 500 \text{ mA}$	1.6		
$ h_{fe} $ Small-Signal Common-Emitter Forward Current Transfer Ratio	$V_{CE} = 10 \text{ V}, I_C = 20 \text{ mA}, f = 100 \text{ MHz}$	2.5		
f_T Transition Frequency	$V_{CE} = 10 \text{ V}, I_C = 20 \text{ mA}, \text{ See Note 4}$	250		MHz
C_{obo} Common-Base Open-Circuit Output Capacitance	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$	8		pF
C_{ibo} Common-Base Open-Circuit Input Capacitance	$V_{EB} = 0.5 \text{ V}, I_C = 0, f = 1 \text{ MHz}$	25		pF
$Re(h_{ie})$ Real Part of Small-Signal Common-Emitter Input Impedance	$V_{CE} = 10 \text{ V}, I_C = 20 \text{ mA}, f = 300 \text{ MHz}$	60		Ω

NOTES: 3. These parameters must be measured using pulse techniques. $t_w = 300 \mu s$, duty cycle $\leq 2\%$.

4. To obtain f_T , the $|h_{fe}|$ response with frequency is extrapolated at the rate of -6 dB per octave from $f = 100 \text{ MHz}$ to the frequency at which $|h_{fe}| = 1$.

switching characteristics at 25°C free-air temperature

PARAMETER	TEST CONDITIONS†	TYP	UNIT
t_d Delay Time	$V_{CC} = 30 \text{ V}, I_C = 150 \text{ mA}, I_{B(1)} = 15 \text{ mA},$	8	ns
t_r Rise Time	$V_{BE(off)} = -0.5 \text{ V}, \text{ See Figure 1}$	12	ns
t_s Storage Time	$V_{CC} = 30 \text{ V}, I_C = 150 \text{ mA}, I_{B(1)} = 15 \text{ mA},$	190	ns
t_f Fall Time	$I_{B(2)} = -15 \text{ mA}, \text{ See Figure 2}$	30	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

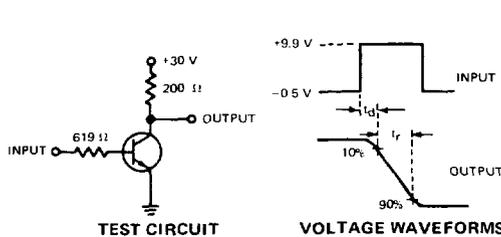


FIGURE 1—DELAY AND RISE TIMES

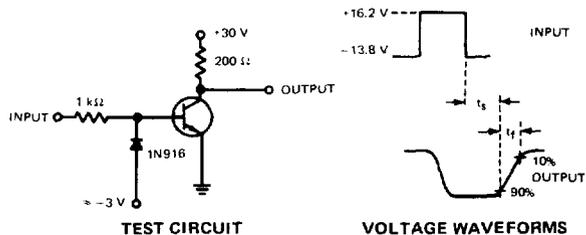


FIGURE 2—STORAGE AND FALL TIMES

NOTES: a. The input waveforms have the following characteristics: for figure 1, $t_r \leq 2 \text{ ns}$, $t_w \leq 200 \text{ ns}$, duty cycle $\leq 2\%$; for figure 2, $t_f \leq 5 \text{ ns}$, $t_w \approx 100 \mu s$, duty cycle $\leq 17\%$.
b. All waveforms are monitored on an oscilloscope with the following characteristics: $t_r \leq 5 \text{ ns}$, $R_{in} \geq 100 \text{ k}\Omega$, $C_{in} \leq 12 \text{ pF}$.